

# **D1FK60**

# Fast Recovery Diodes 600V, 0.8A

## **Feature**

- Small SMD
- High Voltage
- · Low Noise
- · Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

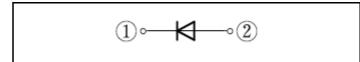
## **OUTLINE**

Package (House Name): 1F

Package (JEDEC Code): DO-214AC



## **Equivalent circuit**



# Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 150	°C
Junction temperature	Tj		-55 to 150	°C
Repetitive peak reverse voltage	$V_{RRM}$		600	V
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, TI=124°C	0.8	Α
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On alumina substrate, Ta=29°C *	0.8	Α
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=33°C *	0.6	Α
Surge forward current	I <sub>FSM</sub>	50Hz sine wave, Non-repetitive 1 cycle, Peak value, Tj=25°C	20	Α

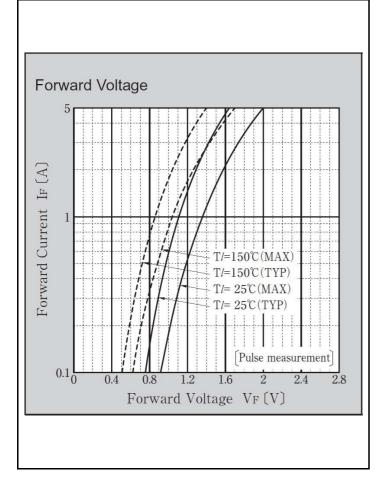
<sup>\* :</sup> See the original Specifications

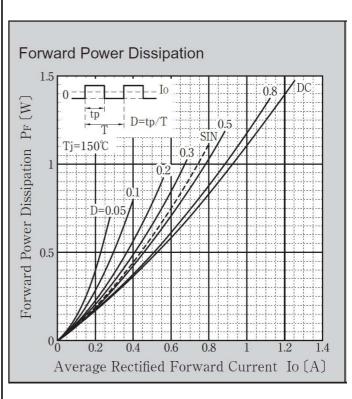
# **Electrical Characteristics** (unless otherwise specified : TI=25°C)

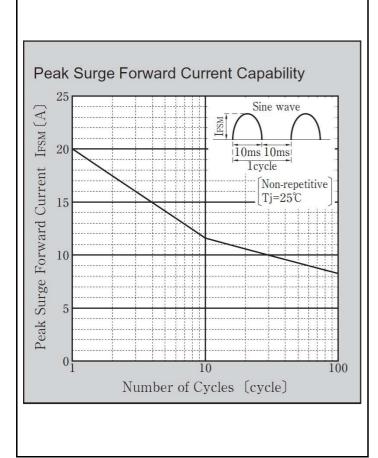
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V <sub>F</sub>	IF=0.8A, Pulse measurement			1.3	V
Reverse current	I <sub>R</sub>	VR=600V, Pulse measurement			10	μΑ
Reverse recovery time	trr	IF=0.5A, IR=1.0A, 0.25IR			75	ns
Total capacitance	Ct	f=1MHz, VR=10V		11		pF
Thermal resistance	Rth(j-l)	Junction to lead			23	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On alumina substrate *			108	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate *			157	°C/W

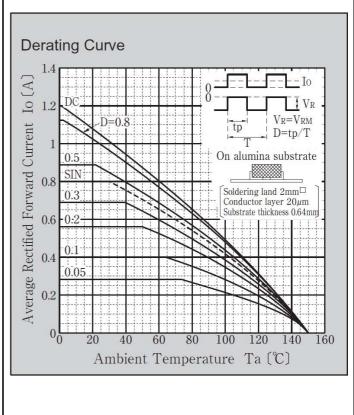
<sup>\*</sup> :See the original Specifications

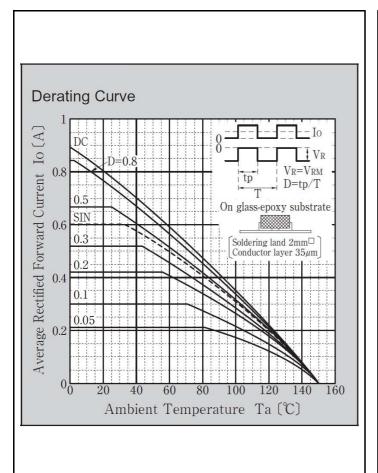
## **CHARACTERISTIC DIAGRAMS**

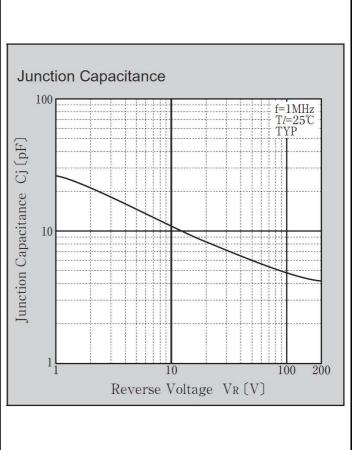








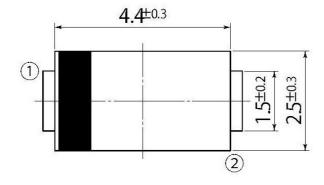


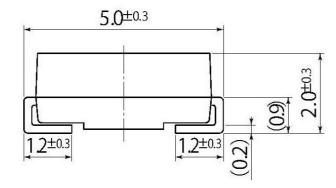


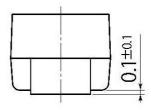
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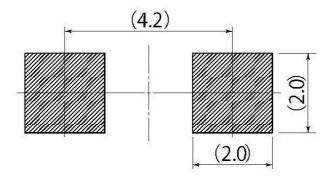
**B3** 

JEDEC Code	DO-214AC		
JEITA Code	-		
House Name	1F		









Referential Soldering Pad

<sup>•</sup> Optimize soldering pad to the board design and soldering condition.

### **Notes**

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